IPC - ASSOCIATION CONNECTED ELECTRONICS INDUST	Copyright 2005. I	Material Composition Declaration © Copyright 2005. IPC, Bannockburn, Illinois. All rights reserved under both international and Pan-American copyright conventions.			der both	This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with lower level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.									
752-21.1		IPC Web Site for Information on IPC-1752 Standard Form Typhttp://www.ipc.org/IPC-175x Distribute				* Declaration Class * Class 6 - RoHS Yes/No. Homogeneous Materi					rials and M	ials and Mfg Information			
upplier Info	rmation						·								
Company name*		Company unique ID			J	Unique ID Authority					Response Date*				
nsemi											2025-07	2025-07-31			
Contact Name		·	Title - Contact			I	Phone - Contact*				Email -	Email - Contact*			
Product-Env-Ste	ewards		Product Enviro Compliance]	NA				Product-Env-Stewards@onsemi.com				
uthorized Repr	esentative*		Title - Representative			I	Phone - Representative*				Email -	Email - Representative*			
Product-Env-Ste	wards		Product Enviro Compliance]	NA				Product-Env-Stewards@onsemi.com				
Reque	ester Item Number			Mfr Item Name			Effective Date	Version	n :	Manufacturing Site		Weight*	UOM	Unit Type	
				EMI FILTER WITH	ΓΗ ESD PROT		2025-07-31				2.743228	mg	Each		
lanufacturin	g Proccess Informa	tion													
Terminal Plating / Grid Array Material T			Terminal Base Alloy J-STD-020 MSL		Rating	Peak Process Body Temperature N		re Max Time at Pea	k Tempera	ture Numb	er of Reflow Cyc	eles			
SnAgCu			CU Alloy 1				260 C 30		30	seconds 3					
omments															
vel 1 - maximun	n time at peak temperatı	are during sol	dering is 10	30 seconds											
or more informa	ation regarding material	composition]	please refer t	o page 3											

RoHS Material Composition Declaration			Declaration Type *	Detail	ed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).											
Please indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2011/65/EU and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury, cadmium, hexavalentchromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a "RoHS restricted substance") in excess of the applicable quantity limit identified above. If a homogeneous material within the part contains a RoHS restricted substance inexcess of an applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, the declaration shall encompass all such components. Supplier certifies that it gathered the information it provides in this form using appropriate methods to ensure its accuracy and that such information is true and correct to the best of its knowledge and belief, as of the date that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive. Company acknowledges that Supplier may have relied on information provided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier has not independently verified information provided by others, Supplier agrees that, at a minimum, its paragraph. If the Company and the Supplier has provided certifications regarding their contributions to the part, and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier has not or written agreement with respect to the identified part, the terms and conditions of that agreement, including any warranty rights and/or remedies of Supplier's Standard Terms and Conditions of Sale applicable to such part shall apply.											
RoHS Declaration * 1 - Item	(s) does not contain RoHS restricted substar	nces per the definition above	Supplier A	cceptance *	Accepted						
Exemption: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.											
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
		e "Accepted" on the Supplier Acceptance	drop-down. This will display the signature a	rea. Digitally sign t	the declaration (if required by the						

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	1.756283	mg	Supplier	Silicon (Si)	7440-21-3		1.7563	mg
Insulating Layer	0.035225	mg		Polyimide	proprietary data		0.0352	mg
Solder Ball	0.907656	mg	Supplier	Silver (Ag)	7440-22-4		0.0091	mg
			Supplier	Tin (Sn)	7440-31-5		0.894	mg
			Supplier	Copper (Cu)	7440-50-8		0.0045	mg
Under Bump Metal	0.044064	mg	Supplier	Titanium (Ti)	7440-32-6		0.0003	mg
			Supplier	Copper (Cu)	7440-50-8		0.0438	mg